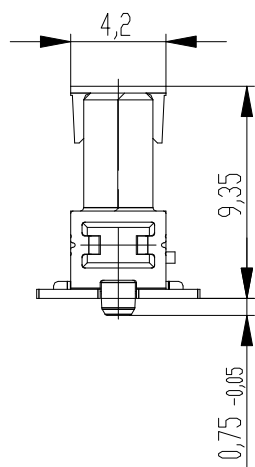
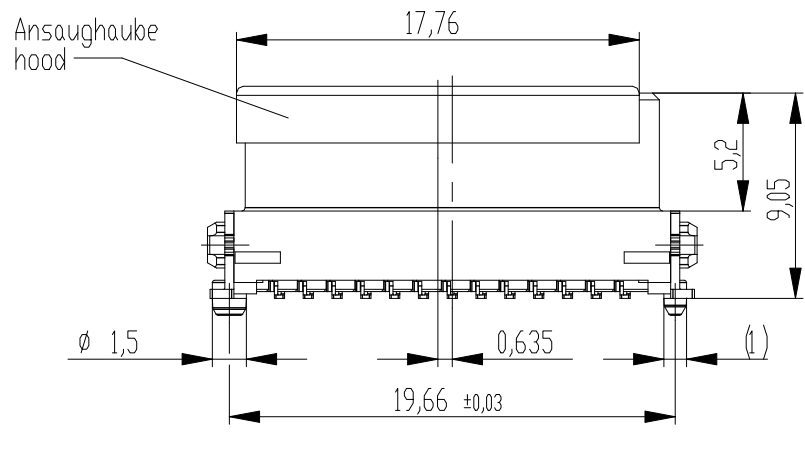
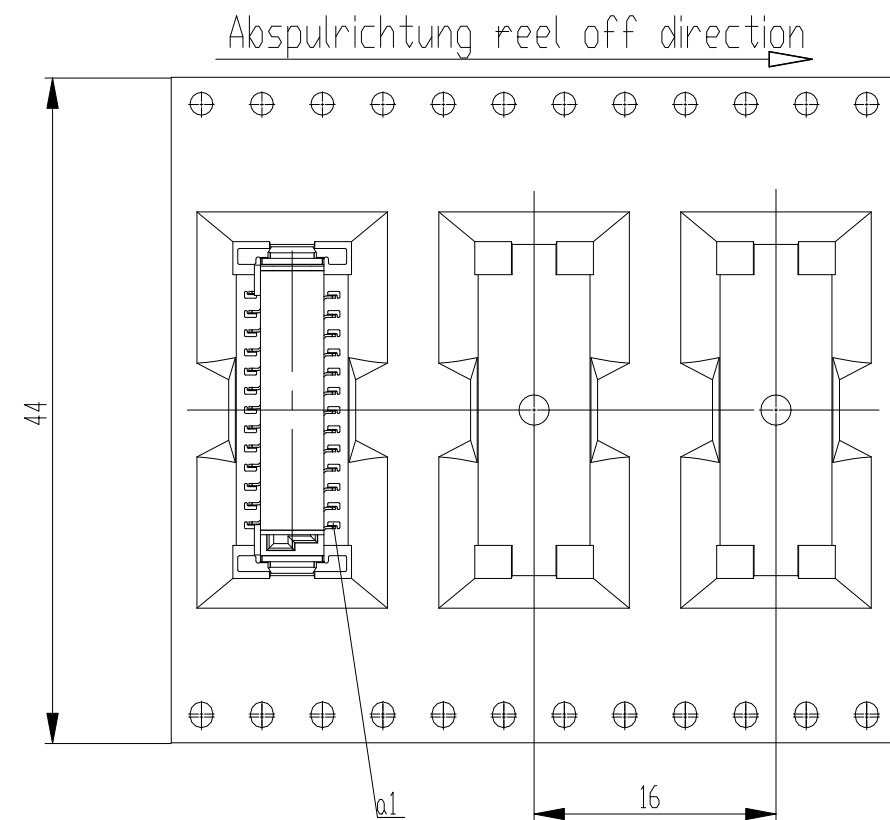
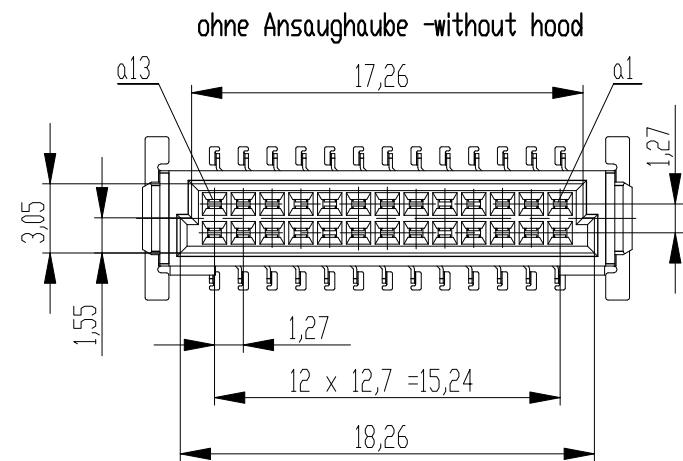
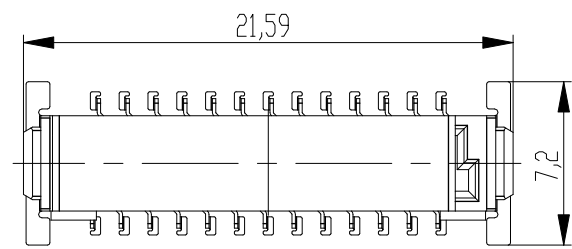
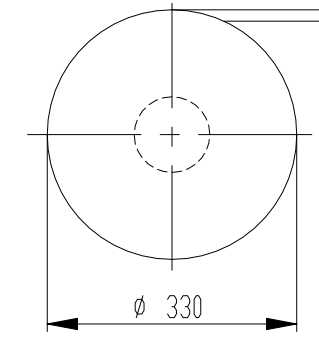


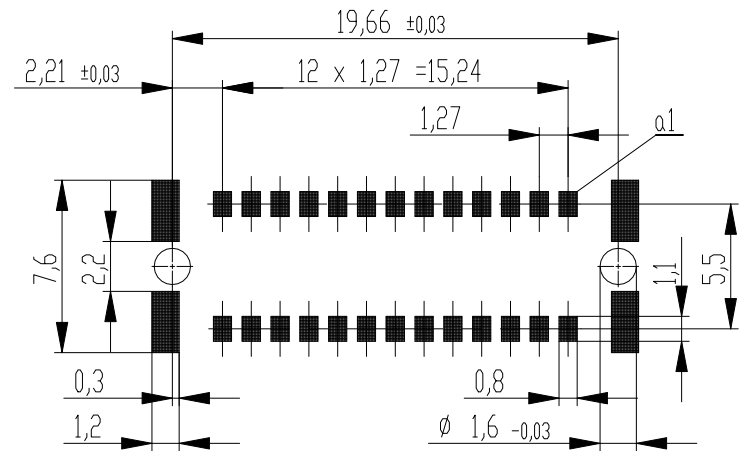
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In case of any deviation the English version shall prevail.
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Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
tape on reel packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
packaging unit: 280 pcs

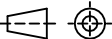


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Anforderungsstufe 1
performance level 1
Kontaktbereich vergoldet
mating area gold plating
Anschlussbereich verzinkt 4-6 µm
terminal area 4-6 µm tin plating
Koplanarität der Anschlüsse ≤ 0,1 mm
coplanarity area of termination ≤ 0,1 mm

BA 7-03 - Standard Bauhöhe
type 7-03 - standard assembly height

Dimension no.				Tolerances Dim. for Information ISO 8015		 All Dimensions in mm		Scale 5:1					
Customer drawing: THIS DRAWING IS A CONTROLLED DOCUMENT.				Subject to modification without prior notice. Drawing will not be updated.		ERNI-Federl. SMC-B 26-SMD-BA7-03 Female SMC-B 26-SMD-type7-03							
h		25.08.2021		 TE Connectivity		©=154718-E						I	
Index		Date										A3	
						Class SMCB							